

Inductors for power circuits **Wound ferrite** VLS-EX-H series (for automotive)











VLS5045EX-H type













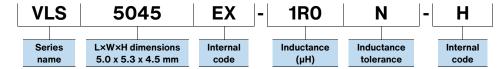
FEATURES

- OMagnetic shield type wound inductor for power circuits.
- OHigh magnetic shield construction achieved by a ferrite magnetic material and compatible with high-density mounting.
- OLarger current and lower Rdc were achieved by optimizing the ferrite core figure.
- Operating temperature range: -40 to +125°C(including self-temperature rise)
- Compliant with AEC-Q200

APPLICATION

OAutomotive-related equipment (ECM, airbags, headlights, electronic power steering, meters, ABS, other)

PART NUMBER CONSTRUCTION



CHARACTERISTICS SPECIFICATION TABLE

L		Measuring frequency	DC resistance	Rated curre	ent*		Part No.
				Isat		Itemp	
(µH)	Tolerance	(kHz)	(Ω)±30%	(A)max.	(A)typ.	(A)typ.	
1.0	±30%	100	0.015	8.9	10	5.1	VLS5045EX-1R0N-H
1.5	±30%	100	0.017	7.4	7.7	5.0	<u>VLS5045EX-1R5N-H</u>
2.2	±30%	100	0.022	6.4	6.6	4.7	VLS5045EX-2R2N-H
3.3	±30%	100	0.027	5.2	5.5	4.2	VLS5045EX-3R3N-H
4.7	±20%	100	0.036	4.4	4.8	3.2	<u>VLS5045EX-4R7M-H</u>
6.8	±20%	100	0.046	3.6	4.0	2.9	VLS5045EX-6R8M-H
10	±20%	100	0.061	3.1	3.2	2.5	VLS5045EX-100M-H
15	±20%	100	0.110	2.2	2.6	1.9	VLS5045EX-150M-H
22	±20%	100	0.125	2.0	2.2	1.8	VLS5045EX-220M-H
33	±20%	100	0.24	1.5	1.7	1.3	VLS5045EX-330M-H
47	±20%	100	0.30	1.3	1.4	1.0	VLS5045EX-470M-H
68	±20%	100	0.41	1.1	1.2	0.90	<u>VLS5045EX-680M-H</u>
100	±20%	100	0.58	0.80	1.0	0.70	VLS5045EX-101M-H
150	±20%	100	0.73	0.56	0.66	0.61	VLS5045EX-151M-H
220	±20%	100	1.05	0.45	0.50	0.45	<u>VLS5045EX-221M-H</u>

^{*} Rated current: smaller value of either lsat or Itemp.

Isat: When based on the inductance change rate (30% below the initial L value)

Itemp: When based on the temperature increase (temperature increase of 40 ℃ by self heating)

Measurement equipment

Measurement item	Product No. *	Manufacturer
L	4294A	Keysight Technologies, Inc. (formerly Hewlett-Packard)
DC resistance	34420A	Keysight Technologies, Inc. (formerly Hewlett-Packard)
Rated current Isat	4284A+42841A+42842A	Keysight Technologies, Inc. (formerly Hewlett-Packard)

^{*} Equivalent measurement equipment may be used.

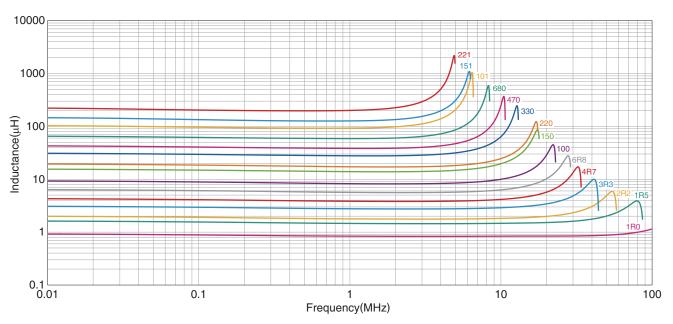






VLS5045EX-H type

L FREQUENCY CHARACTERISTICS

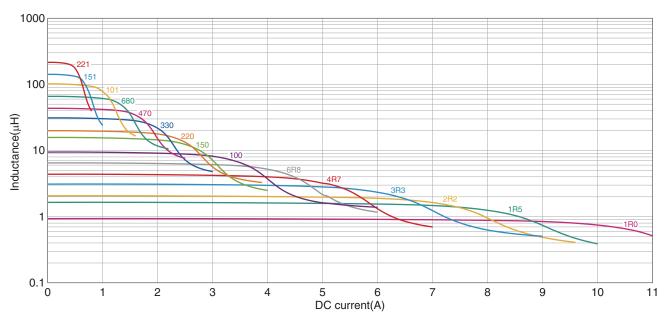


Measurement equipment

Product No. *	Manufacturer
4294A	Keysight Technologies, Inc. (formerly Hewlett-Packard)

^{*} Equivalent measurement equipment may be used.

INDUCTANCE VS. DC BIAS CHARACTERISTICS



Measurement equipment

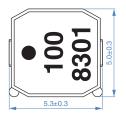
Product No. *	Manufacturer
4284A+42841A+42842A	Keysight Technologies, Inc. (formerly Hewlett-Packard)

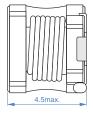
^{*} Equivalent measurement equipment may be used.

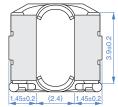


VLS5045EX-H type

SHAPE & DIMENSIONS



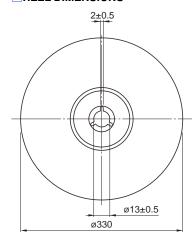


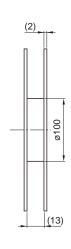


Dimensions in mm

PACKAGING STYLE

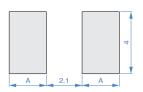
REEL DIMENSIONS





Dimensions in mm

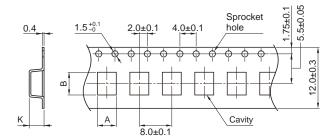
RECOMMENDED LAND PATTERN



Solder fillet required	2
Solder fillet not required	1.7

Dimensions in mm

TAPE DIMENSIONS



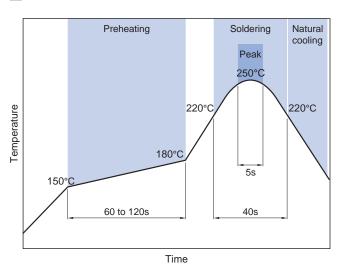
Dimensions in mm

Туре	Α	В	К
VLS5045EX-H	5.35	5.65	4.7

□PACKAGE QUANTITY

Package quantity	1,500 pcs/reel		

RECOMMENDED REFLOW PROFILE



TEMPERATURE RANGE, INDIVIDUAL WEIGHT

Operating temperature range *	Storage temperature range **	Individual weight
-40 to +125 °C	-40 to +125 °C	0.4 g

^{*} Operating temperature range includes self-temperature rise.

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^{**} The storage temperature range is for after the assembly.



REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using this products

REMINDERS

С	The storage period is within 12 months. Be sure to follow the storage RH or less).	ge conditions (temperature: 5 to 40°C, humidity: 0 to 75%
	If the storage period elapses, the soldering of the terminal electrod	les may deteriorate.
C	ODo not use or store in locations where there are conditions such as	gas corrosion (salt, acid, alkali, etc.).
С	Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature temperature does not exceed 150°C.	difference between the solder temperature and chip
C	Soldering corrections after mounting should be within the range of If overheated, a short circuit, performance deterioration, or lifespar	·
C	When embedding a printed circuit board where a chip is mounted to due to the overall distortion of the printed circuit board and partial	·
C	Self heating (temperature increase) occurs when the power is turne thermal design.	ed ON, so the tolerance should be sufficient for the set
С	Carefully lay out the coil for the circuit board design of the non-maged A malfunction may occur due to magnetic interference.	gnetic shield type.
C	Ouse a wrist band to discharge static electricity in your body through	h the grounding wire.
C	On not expose the products to magnets or magnetic fields.	
C	ODo not use for a purpose outside of the contents regulated in the do	elivery specifications.
C	The products described in this catalog are intended to be installed a equipment, telecommunications equipment, home appliances, amuse equipment, office equipment, measurement equipment, industrial runder the said automotive product is mounted in a vehicle) or standard applications as general electron the scope and conditions described in this specification, while the said product is intended to be used in the usual operation and usage automotive products are not designed or warranted to meet the receptormance and/or quality requires a more stringent level of safeticause serious damage to society, person or property. Please understand that we are not responsible for any damage or liable below or for any other use exceeding the range or conditions set for lifyou intend to use the products in the applications listed below or conditions set forth in this specification, please contact us.	usement equipment, computer equipment, personal robots) and to be used in automobiles (including the case idard applications as general electronic equipment in inic equipment in automotive applications in accordance with aid automotive or general electronic equipment including the ge methods, respectively. Other than automotive or quirements of the applications listed below, whose by or reliability, or whose failure, malfunction or defect could subility caused by use of the products in any of the applications orth in this specification sheet.
	(1) Aerospace/aviation equipment (7)	Transportation control equipment
	()	Dublic information processing acresings

- (2) Transportation equipment (electric trains, ships, etc.)
- (3) Medical equipment
- (4) Power-generation control equipment
- (5) Atomic energy-related equipment
- (6) Seabed equipment

- (8) Public information-processing equipment
- (9) Military equipment
- (10) Electric heating apparatus, burning equipment
- (11) Disaster prevention/crime prevention equipment
- (12) Safety equipment
- (13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.